

Zynq RFSoC DFE

OVERVIEW

Xilinx® Zynq® RFSoC DFE is a breakthrough adaptable radio platform that hardens the digital front-end (DFE) for 5G mass radio deployment and a breadth of other RF applications.

Built on the only production-proven, adaptive single-chip radio platforms that integrate the entire signal chain from RF to baseband, Zynq RFSoC DFE represents a new class of devices that integrates hardened DFE IP along with Xilinx's proven Programmable Logic. Zynq RFSoC DFE offers the best balance of technologies - the cost economies of an ASIC using hardened blocks with the flexibility, scalability and time-to-market benefits of a programmable and adaptive SoC.

HIGHLIGHTS

Fully Hardened Radio Subsystem for 5G NR Performance and Power

- > Validated 3GPP Standards compliant radio cores
- > Half the power of Zynq RFSoC Gen 3 for typical radio applications
- > Up to 7.125GHz RF bandwidth
- > Industry's only 400MHz iBW for 8T8R
- > Supports both FR1 and FR2 radio DFE with flexible and scalable DFE
- > Flexibility to enhance hardened IP with adaptive logic

Multi-Band, Multi-Mode Operation for Flexibility and Scalability

- > Up to 8 component carrier per-antenna path (8T8R FDD/TDD)
- > 400MHz iBW support enables RAN sharing (e.g., MORAN)
- > Ability to support multi-mode, multi-band radios with a single device

Complete Adaptive SoC for Fully Software-Defined Radio

- > Based on the proven 16nm UltraScale™ architecture
- > Arm® processing subsystem for DFE configuration and control
- > Adaptive logic for differentiation and future market requirements
- > 32G transceivers with RS-FEC for CPRI, eCPRI, and ORAN FH interfaces
- > 100G Ethernet integrated cores





TARGET APPLICATIONS

5G New Radio (5G NR)

- > Massive MIMO Macrocell
- > Multi-Mode (4G/5G) Macrocell
- > Fixed Wireless Access
- > Small Cell Nodes

Aerospace & Defense

- > 5G for Government / Private Spectrum
- > Digital Phased Array Radar
- > Milcom and Satcom Modems
- > Data Links
- Positioning, Navigation, and Timing (e.g., GPS Anti-Jam)

Test & Measurement

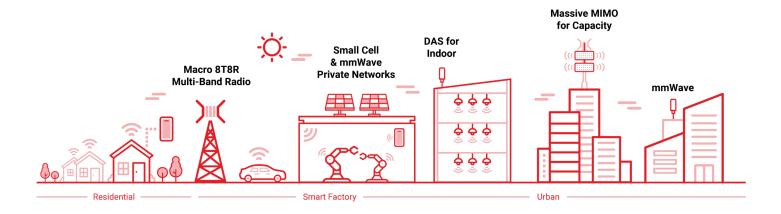
- > Portable Test Equipment
- > UE Emulation / RF Testers

FEATURES Zyng RFSoC DFE

Zynq RFSoC DFE integrates much of the DFE and RF processing required by both 4G and 5G NR.

HARDENED RADIO SUBSYSTEM	
Direct RF Data Converters	 8x 10GSPS DACs 8x 2.5GSPS ADCs and 2x 5.9GSPS ADCs Direct RF support for all FR1 bands, optimal IF for mmWave FR2 bands Up to 7.125GHz RF bandwidth Integrated mixer, NCO, interpolation & decimation for digital frequency conversion
RF Signal Processing	> Specialist signal processing including resampling and equalization
Digital Pre-Distortion	 Supports up to 400MHz iBW and the latest RF power amplifier technologies Reduced weight and thermal management complexity in the radio Based on production-proven Xilinx IP
Crest Factor Reduction	 Supports up to 400MHz instantaneous bandwidth (iBW) Based on production-proven Xilinx IP
Digital Up-Conversion (DUC) Digital Down-Conversion (DDC)	 Support for up to 8 component carriers (CCs) Supports a wide range of carrier bandwidths and 400MHz iBW
Channel Filtering	 Support for up to 8 component carriers (CCs) Supports a wide range of carrier bandwidths for 4G and 5G NR

Covering a wide range of radio requirements from small cell and DAS to macro and massive MIMO



TAKE THE NEXT STEP

Visit www.xilinx.com/rfsoc-dfe

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